ALPHA

TECHNICAL BULLETIN

LONCO ROSIN FLUX 800 (RF800) NO-CLEAN FLUX

RF800 provides the broadest process window for a no-clean flux with less than 5% solids content. RF800 is designed to provide excellent soldering results (low defects rates), even when the surfaces to be soldered (component leads and pads) are not highly solderable. RF800 works particularly well with bare copper boards protected with organic or rosin/resin coatings and with tin-lead coated PCB's.

GENERAL DESCRIPTION

RF800 is a very active, live solids, no-clean flux, it is formulated with a proprietary activatory system. A small percentage of rosin is added for enhanced thermal stability. The activators are designed to provide the brackets operating wildow for a low solids, no-clean flux, while maintaining a high level of long-term elicitical reliability. After awas soldering, RF800 leaves a low level of non-tacky residue, which is easily penetable in pin testing.

FEATURES & BENEFITS

- Highly active for excellent soldering and low defect rates.
- Low level of non-tacky residue to reduce interference with pin testing.
- Cleaning is not required which reduces operating costs.
- Reduces the surface tension between solder mask and solder to significantly reduce solder ball frequency.
- Meets Belicore requirements for long-term electrical reliability.

APPLICATION GUIDELINES

PREPARATION - In order to maintain consistent soldering performance and electrical reliability, it is important to begin the process with circuit boards and components that meet established requirements for solderability and ionic cleanliness. It is suggested

that assemblers establish specifications on these larms with their suppliers and that suppliers provide Certificates of Analysis with shipments and/or assemblers perform incoming inspection. A common specification for the inici clearitiness of incoming boards and components is Syg(In² maximum, as measured by an Omeganeter with headed solution.

Care should be taken in handing the circuit boards throughout the process. Boards should always be held at the edges. The use of clean, int-free gives is also recommended. When switching from one flux to another, the use of a new foam store is recommended (for foam fluxing).

Conveyors, fingers and pallets should be cleaned. Bioact SC-10 Solvent Cleaner has been found to be very useful for these cleaning applications. When foam fluxing, do not use hot futures or pallets. Hot futures/sallets will deteriorate the foam head.

FLUX APPLICATION - RF800 is formulated to be applied by foam, wave or apray methods. When foam funning, the foam fluxer should be applied with compressed air which is free of oil and water. Keep the flux tank full at all firms. The flux level should be maintained 11 into 1-5 is inches above the top of the stome. Adjust the air pressure to produce the optimum foam heaph with a fine, uniform flaxen head. A uniform coating of flux is essential to successful soldering. When using the foam or wave method of application, an air knife is recommended after the fluxing operation. An air knife will help ensure that the flux is uniformly distributed across the board and will remove the excess flux.

LONCO ROSIN FLUX 800 (RF800)

When spray fluxing, the uniformity of the coating can be visually checked by running a piece of cardboard over the spray fluxer or by processing a board-sized piece of tempered glass through the spray and then through the preheat section.

GENERAL GUIDELINES FOR MACHINE SETTINGS

OPERATING PARAMETER	TYPICAL LEVEL
Amount of Flux Applied	Foam, Wave: 1,000 - 2,000 µg/m ² of solids Spray: 750 - 1,500 µg/m ¹ of solids
When foam fluxing	
Foam Stone Pore Size	20 -50 µm
Distance that top of stone is submerged below flux	1 - 11/2 inches (25 - 40 mm)
Foam Fluxer Chimney Opening	3/8 - 1/2 inch (10-13 mm)
When foam fluxing, use an Air Knife Air Knife Hole Diameter	1-1.5 mm
Distance Between Holes	4-5 mm
Distance from Fluxer to Air Knife	4 - 6 inches (10-15 cm)
Air Knife Angle Back toward Fluxer from Perpendicular	3°-5°
Topside Preheat Temperature	190°F - 230°F (85°C - 110°C)
Bottomside Preheat Temperature	about 65°F (35°C) higher than topside
Maximum Ramp Rate of Topside Temperature (to avoid component damage)	2°C/second (3.5°F/second) maximum
Conveyor Angle	5°-8° (6° most common)
Conveyor Speed	4 - 6 feet/minute (1.2 - 1.8 meters/minute)
Contact Time in the Solder (includes Chip Wave and Primary Wave)	1.5 - 3.5 seconds (2-21/2 seconds most common
Solder Pot Temperature	460 - 500°F (235-260°C)

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FLUX SOLIDS CONTROL. If Sam, wave, or oring drum samp fulling. The flux solids will need to be controlled via thinner addition to replace evaporative losses of the flux rolent. A with may flux with less than 5% solids content, specific gravity is and an effective measurement for assessing and controlling the solids content. Newtoining and instaining the solids content. New instantion should be controlled to between 17 and 19. Aphris 2% Solids Control K 28, a digital trace, is suggested. Request Alpha's Technical Bulletin SMed Ster forelias in the kiral of thation procedure. When operating the foam fuxer continuously, the add turnher should be checked every two to four hours. Dure time, debits and contaminants will accomutate in exclusifing type interactive states and the states soldering performance, dispose of spent fux every 40 hours of operation. After engitying the flux, the meanor and foam store should be thoroughly cleaned with flux threer. RESIDUE REMOVAL - RF800 is a no-clean flux and the residues are designed to be left on the board. However, if desired, RF800 residues can be removed with Alpha 2110 Saporifier.

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TOUCH-UP/REWORK - Use of the Cleanline Write Flux Applicator with NR205 flux and Telecore Plus corred solider is recommended for hand solidering applications.

Parameters	Typical Values	Parameters/Test Method	Typical Values
Appearance	Pale, yellow liquid	pH (5% aqueous solution)	3.4
Solids Content, wt/wt	4.1	Recommended Thinner	800 Additive
Acid Number (mg KOHig)	18	Shelf Life	18 Months
Specific Gravity @ 25°C (77°F)	0.794 ± 0.003	Container Size Availability	1, 5, and 55 Gal.
Pounds Per Gallon	6,6	Belicore TR-NWT-000078, Issue 3 Compliant	Yes
Flash Point (T.C.C.)	56°F (13°C)	1	

CORROSION AND ELECTRICAL RELIABILITY TESTING			
Corrosion Testing Silver Chromate Paper Test	Requirements No Detection of Halide	Results Passes	
Copper Mirror Test	No Complete Removal of Copper	Passes	
IPC Copper Corrosion Test		No Corrosion (Type L)	

Test Condition Belicore "Comb-Down" - U	Incleaned		irement 1 minimum	A5x1	
Belicore "Comb-Up" - Uno	leaned	1.0 x 10	" minimum	6.7 x 1	011
Belicore Control Board		2.0 x 10	" minimum	1.6 x 1	012
IPC J-STD-004 Comb-Do Uncleaned	wn	1.0 x 10	* minimum	1.1 x 1	010
IPC J-STD-004 Comb-Up	Uncleaned	1.0 x 10	minimum	9.8 x 1	10°
IPC J-STD-004 Control Br	sard			1.1 x 1	O10
Belicore Test Condition (per	TR-NWT-000078, I	ssue 3): 35°C/85	%RH/120 Hours/-48 volts, measu	rement @ 100%	ψ
25 mil lines/50 mil spacing. IPC Test Condition (per J-ST spacing).	D-004): 85*C/85%	RH/168 Hours/-5	hiRH/120 Hours/48 volts, measu 0V, measurement @ 100V/IPC B-		
25 mil lines/50 mil spacing.	D-004): 85°C/85% DN (all values	RH/168 Hours/-5			

(12.5 mil lines, 12.5 mil spacing)

HEALTH & SAFETY

Please refer to the Material Safety Data Sheet as the primary source of health and safety information. Inhalstion of the flux solvent and veltalized activator turnes which are generated at soldering temperatures. may cause headsches, dizziness and nuusea. Suitable fume extraction equipment should be used to remove the flux from the work area. An exhaust at the exit end of the wave solder machine may also be

needed to completely capture the fumes. Observe precautions during handling and use. Suitable

The information contained heads in based on considered accountie and to offered at no charge. No example, in expressed or implied segarating the accouncy of this data. Labelly is expressly declared for any foce or many anong out of the value of this information or the use of any materials designated. protective clothing should be worn to prevent the material from coming in contact with skin and eyes. RF800 flux contains a highly flammable solvent with a flashpoint of 56°F (13°C). The flux must not be used

near open flames or near non-flameproof electrical equipment.

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